CHIP CHARACTERISTICS FOR Tektronix TK2048EB 1522BR07-01

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1 General Description

Chip type	: Tektronix TK2048EB Grade Engineering, thinned, AR coated, MPP
Chip characteristics	s: AR coating: ,
Chip format	: 2048x2046, 19 pre-scan pixels in horizontal direction
Pixel size	$: 24 \ge 24 \mu m^2$
Serial No.	: 1522BR07-01

The cryostat electronic board has special clock shaping capacitors for this CCD (C57-60: 1000pF, C61-64: open, C65-68: 150nF, C69-72: 2.2nF).

2 Flatness of the chip

The surface of the CCD can be fitted with a sphere of a radius of 2050mm \pm 190mm. The definition is bad.

3 System Setup

This chip has been tested with the ESO-VME CCD camera system.

The clock-pattern tk2048eadmpp with MPP-mode have been used for the tests.

Parameters are set to SUBPATT 3 and GAIN 2, if not otherwise mentioned.

All tests were performed between 160 K and 180 K, if not otherwise mentioned.

4 Voltage Setup

See table 1 on page 2 for all voltage values.

 VL01 : -8.00 VHI1 : 3.02 VL02 : -8.00 VHI2 : 3.03

 HL01 : -4.01 HHI1 : 6.07 HL02 : -4.02 HHI2 : 6.07

 RL01 : 0.007 RHI1 : 13.00 RL02 : -8.01 RHI2 : 6.03

 VDD1 : 23.48 VDR1 : 15.25 VDD2 : 22.83 VDR2 : 14.16

 VGS1 : -2.16 VSS1 : 0.00 VGS2 : -9.02 VSS2 : 0.00

 Table 1: Telemetry values

for A, B, C and D amplifier

5 Noise and Gain

Amplifier A:

The conversion factor is (at GAIN = 2)

 $2.634 \pm 0.086 \text{ e}^-/\text{ADU}$. at subpatt 3

The readout-noise is

 $7.5 \pm 0.4 \ e^- \ RMS$ at subpatt 3

Amplifier B:

The conversion factor is (at GAIN = 2)

 $1.695 \pm 0.136 \text{ e}^-/\text{ADU}$. at subpatt 3

The readout-noise is

 $5.6 \pm 0.6 \ e^- \ RMS$ at subpatt 3

Amplifier C:

The conversion factor is (at GAIN = 2)

 $10.000 \pm 0.761 \text{ e}^-/\text{ADU}$. at subpatt 1

5.239 \pm 0.130 e⁻/ADU. at subpatt 2

 $2.693 \pm 0.050 \text{ e}^-/\text{ADU}$. at subpatt 3

 $2.635\pm0.158 \text{ e}^-/\text{ADU}$. at subpatt 3 and 2x2 binning

 $1.335 \pm 0.044 \text{ e}^-/\text{ADU}$. at subpatt 4

The readout-noise is

 $11.2{\pm}1.3~{\rm e^-}~{\rm RMS}$ at subpatt 1

 $\mathbf{8.8}{\pm}0.4~\mathbf{e}^ \mathbf{RMS}$ at subpatt 2

 $7.4{\pm}0.2~{\rm e^-}~{\rm RMS}$ at subpatt 3

 $7.8{\pm}0.7~{\rm e^-}~{\rm RMS}$ at subpatt 3 and 2x2 binning

 $\mathbf{6.3}{\pm}0.5~\mathbf{e^-}~\mathbf{RMS}$ at subpatt 4

Amplifier D:

The conversion factor is (at GAIN = 2)

 $2.496 \pm 0.074 \text{ e}^-/\text{ADU}$. at subpatt 3

The readout-noise is

 $9.4 \pm 0.5 e^- RMS$ at subpatt 3

The noise and gain was measured using the HP-desktop procedure "MEASURE CON-FACT" at different illumination levels. This procedure takes two equal dark– and two equal flat-field exposures calculating noise and gain independent from the light level with the variance of the difference of the two flat-fields.

6 Pick-up Noise

At slow-mode pick-up noise could be seen very weak at short dark exposures.

7 Quantum Efficiency

CCD SENSITIVITY CALIBRATION:

Detecto Calibra Detecto e-/[ADU System Misc.Co	or ID ated ag or area J] gain omments	gainst a (cm2) s	: TK2 : _SD) : 5.7 : 2. : : tk2	0152 C1_NP 6E-06 69 2 048ec1	De _1 T _ Us Su ompp_1	etector ype SO CCD sed Out ibpatte 522CR07	No. put(s) rn 7-01	: Tektronix : TK2048EB : 1333 : 0 : 3	
CCD Sys	stem va	lues	:		Scann	ed CCD	area		
Hor. ac Tot. ve Hor. E Vert. E	ct. Pix ert. Li Sinning Sinning	els nes S	: 20 : 20 :	86 60 1 1	F: L: F: L:	irst pi ast pix irst li ast lin	xel el ne e	: 25 : 2063 : 5 : 2043	
Lambda [nm]	Time [sec]	Dens [log]	Temp C [K]	ounts [ADU]	RQE [%]	+/- [%]	Sensitivity [A/(W/cm2)]	Photon flux [Phot/cm2]	Irradiance [W/cm2]
******	*****	*****	******	****	*****	******	*****	******	******
320	300	0.0	161.8	621	23.48	1.66	+3.511E-07	+4.123E+06	+2.543E-12
340	300	0.0	161.8	3208	32.81	2.95	+5.195E-07	+1.524E+07	+8.876E-12
360	300	8.6	161.8	4222	43.51	4.35	+7.283E-07	+1.513E+07	+8.333E-12
380	60	8.6	161.8	4104	54.99	5.43	+9.728E-07	+5.817E+07	+3.032E-11
400	40	0.0	161.8	6094	65.40	5.72	+1.212E-06	+1.089E+08	+5.419E-11
450	10	0.0	161.8	5841	64.02	3.62	+1.336E-06	+4.266E+08	+1.885E-10
500	10	.3	161.8	5948	68.20	2.85	+1.583E-06	+4.078E+08	+1.620E-10
550	10	.8	161.8	5246	71.75	2.71	+1.834E-06	+3.419E+08	+1.234E-10
600	10	.9	161.8	5508	75.39	2.70	+2.097E-06	+3.416E+08	+1.132E-10
650	10	.9	161.8	6225	76.76	2.55	+2.294E-06	+3.792E+08	+1.170E-10
700	10	.9	161.8	8293	77.56	2.44	+2.519E-06	+5.000E+08	+1.419E-10
750	10	.9	161.8	5274	70.56	2.28	+2.454E-06	+3.495E+08	+9.267E-11
800	10	.9	161.8	6705	64.81	2.16	+2.405E-06	+4.838E+08	+1.202E-10
850	10	.9	161.8	6846	51.86	1.92	+2.049E-06	+6.172E+08	+1.440E-10
900	10	.6	161.8	5925	37.41	1.60	+1.562E-06	+7.406E+08	+1.635E-10
950	10	.4	161.8	6245	24.43	1.23	+1.076E-06	+1.195E+09	+2.503E-10
1000	20	. 5	161.8	6153	11.34	.72	+5.253E-07	+1.269E+09	+2.525E-10
Calibra	ation_e	error=	1.5	0% Ca	onvers	ion_fac	tor_error=	1.85%	

_TK20152_21 stored on /users/ms/cali:HFS at 16 Jun 1995 07:25:33

Table: RQE measurement protocols for the CCD chip

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Figure 1: Plot of RQE values of the CCD (complete surface) at 161 K

The RQE was measured in an automatic mode using the test-bench computer. The quantum-efficiency values and their errors are listed below. The given error is the geometrical sum of the error of test-bench calibration (approximate 1.5 %), the error of the CCD conversion factor measurement (approximate 1.85 %) and of the variation of the quantum-efficiency over the whole chip surface (dependent from the light wavelength). The variation of quantum efficiency over the chip can be seen in detail in the homogeneity measurement in section 14 on page 9.

The peak value for RQE of CCD was approx. 77 % at 700nm.

Figure 1 on page 5 shows the plot of QE for the CCD.

8 Charge Transfer Efficiency

TBD

9 Dark Current

The dark current was measured with a 20 minutes dark exposures with MPP-mode after more than 5 hours in the dark wiping the CCD every minute.

The mean dark current rate is approx. $6.95 \pm 1.9 \ e^{-}/pixel/hour$ at 161 K.

10 Linearity

Linearity was measured taking exposures of the same exposure-time at different light levels and at a wavelength of 700 nm.

Amplifier A:

There is a maximum deviation of less than $\pm 0.93\%$ from the average value within 1.73 decades from 480 to 26000 e⁻ per pixel.

Amplifier B:

There is a maximum deviation of less than $\pm 0.94\%$ from the average value within 3.1 decades from 54 to 66550 e⁻ per pixel.

Amplifier C:

There is a maximum deviation of less than $\pm 0.94\%$ from the average value within 2.2 decades from 284 to 48300 e⁻ per pixel.

Amplifier D:

There is a maximum deviation of less than $\pm 0.88\%$ from the average value within 3.15 decades from 45 to 63510 e⁻ per pixel.

See figure 2 on page 6 for details.



Figure 2: Linearity Measurement with amplifier B

In view of the other problems with this CCD, the linearity was not optimized with the voltage setup.

11 Full well capacity

The full well capacity was measured with flat-field exposures of high intensities in MPP– mode. The limit of linearity is reached, if at higher intensities the deviation from linearity starts to get larger than the given maximum deviation in the section 10 on page 6.

Amplifier B:

Upper limit of linearity: 222 000 e⁻/pixel Saturation-value: 351 000 e⁻/pixel

Amplifier C:

Upper limit of linearity: 266 000 e⁻/pixel Saturation-value: 470 000 e⁻/pixel

Horizontal voltage has to be adjusted to prevent charge smearing at high illumination values.

12 Cosmic Ray Events

The Cosmic Ray Event rate was measured using our standard method (MIDAS Batch: COSMIC) to count *events* independently of their actual size.

The cosmic ray event rate is 2.83 + 0.2 - 0.2 events/min/cm².

13 Blemishes

With the Amplifier A we found 35589 defective pixels. This was measured using three weak light images with a level of approximate $300 e^-$ per pixel (see page 8) and an automatic MIDAS-procedure to identify and catalogue the defects.

This test is very sensitive: A column defect is any defect which is longer than 10 pixels and a defect is any pixel which is lower than 50 % or higher than 200 % of the mean level of a weak light flat field exposure.

Number of hot defects: Hot spots: 0; Hot cluster: 0; Hot columns: 0 Number of dark defects: Dark pixel: 2; Dark cluster: 85; Dark columns: 175; Traps: 116 Number of all defects: 378



Frame	: weakmean
Identifier	: average frame
ITT-table	: ramp.itt
Coordinates	: 1, 1 : 2077, 2045
Pixels	: 1, 1 : 600, 600
Cut values	: 315.53, 372.86
User	: ehummel

Figure 3: Weak Flat field (700 nm, 2.5): approx. 300 e⁻ per pixel with amplifier A.

14 Uniformity

The homogeneity was measured using a standard method of sampling the whole sensitive area and using the RMS value of it. Values of deviations from homogeneity are given in table 2 on page 9.

Flat-field exposure	Maximal RMS Deviation
at a wavelength	from mean value
in [nm]	in [%]
320	6.67
340	8.66
360	9.70
380	9.59
400	8.41
450	5.13
500	3.44
550	2.94
600	2.67
650	2.31
700	2.05
750	2.19
800	2.33
850	2.83
900	3.56
950	4.42
1000	5.88

Table 2: Uniformity of the CCD

15 Remanence

Exposure	Exposure	Illumination	CCD	Remanence
Type	Time	$_{ m in}$	Satu-	$_{ m in}$
	in $[sec]$	[photons/pixel]	ration	[e ⁻ per pixel]
FF white	1(Dens=1)	203000	0.28	
DK	600	_		5
FF white	1	1786000	2.47	
DK	600	_		7
DK	600	_		6
DK	600	_		5
FF white	10	17860000	24.7	
DK	600	_		—
DK	600	_		—
DK	600			—

Table 3: Remanence of the CCD at 161 K

The Remanence test was made after 10 hours in the dark and periodical wiping at at temperature of 161 K. After a high level flat field with white light which give oversaturation on the CCD, several ten minutes dark exposures have been taken. The mean level in the centre of these dark exposures was compared with the mean level of a ten minute dark before these saturations and the remanence in e^- per pixel has been calculated. The results can be seen in table 3 on page 10.

References

- S. Deiries, M. Cullum: ESO Maintenance Manual No.5 July 89, CCD Cryostat for new VME-based Control Camera.
- [2] J. Janesick, JPL: Private communication